

0.8 A Three-quadrant triacs high commutation

Rev. 01 — 18 January 2008

Product data sheet

Product profile

1.1 General description

Passivated, guaranteed commutation, sensitive gate triacs in a SOT54 plastic package

1.2 Features

- Guaranteed commutation performance
 Easily interfaced with low power drivers at each gate sensitivity
- Sensitive gate

including microcontrollers

1.3 Applications

Motor control

Solenoid drivers

1.4 Quick reference data

- $V_{DRM} \le 600 \text{ V (BTA2008-600D)}$
- $V_{DRM} \le 600 \text{ V (BTA2008-600E)}$
- $V_{DRM} \le 800 \text{ V (BTA2008-800D)}$
- $V_{DRM} \le 800 \text{ V (BTA2008-800E)}$
- $I_{TSM} \le 9 \text{ A (t = 20 ms)}$

- I_{GT} ≤ 5 mA (BTA2008-600D)
- $I_{GT} \le 5 \text{ mA (BTA2008-800D)}$
- $I_{GT} \le 10 \text{ mA (BTA2008-600E)}$
- $I_{GT} \le 10 \text{ mA (BTA2008-800E)}$
- $I_{T(RMS)} \le 0.8 A$

2. Pinning information

Table 1. **Pinning**

	3		
Pin	Description	Simplified outline	Graphic symbol
1	main terminal 2 (T2)	-	N.I.
2	gate (G)		T2—
3	main terminal 1 (T1)		`G sym051
		SOT54 (TO-92)	



3. Ordering information

Table 2. Ordering information

Type number	Package				
	Name	Description	Version		
BTA2008-600D	TO-92	plastic single-ended leaded (through hole) package; 3 leads	SOT54		
BTA2008-600E					
BTA2008-800D					
BTA2008-800E					

4. Limiting values

Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DRM}	repetitive peak off-state voltage	BTA2008-600D; BTA2008-600E	<u>[1]</u> -	600	V
		BTA2008-800D; BTA2008-800E	-	800	V
I _{T(RMS)}	RMS on-state current	full sine wave; $T_{lead} \le 70$ °C; see Figure 4 and 5	-	8.0	Α
I _{TSM}	non-repetitive peak on-state current	full sine wave; $T_j = 25$ °C prior to surge; see Figure 2 and 3			
		t = 20 ms	-	9	Α
		t = 16.7 ms	-	9.9	Α
I ² t	I ² t for fusing	t _p = 10 ms	-	0.41	A ² s
dI _T /dt	rate of rise of on-state current	$I_{TM} = 1.5 \text{ A}; I_G = 20 \text{ mA};$ $dI_G/dt = 0.2 \text{ A}/\mu\text{s}$	-	100	A/μs
I_{GM}	peak gate current		-	1	Α
P_{GM}	peak gate power		-	5	W
$P_{G(AV)}$	average gate power	over any 20 ms period	-	0.1	W
T _{stg}	storage temperature		-40	+150	°C
T _j	junction temperature		-	125	°C

^[1] Although not recommended, off-state voltages up to 800 V may be applied without damage, but the triac may switch to the on-state. The rate of rise of current should not exceed 6 A/μs.

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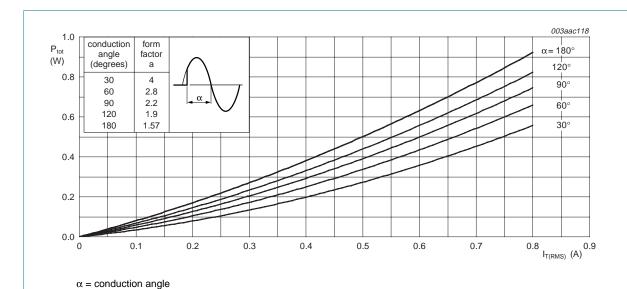
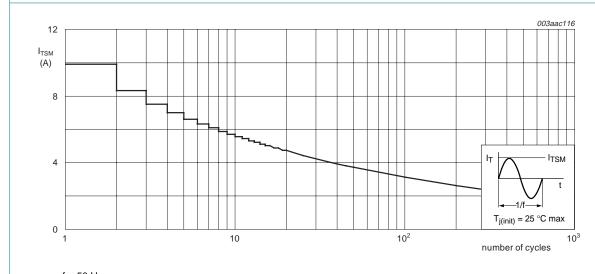
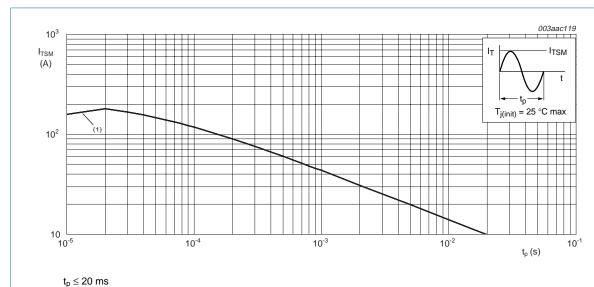


Fig 1. Total power dissipation as a function of RMS on-state current; maximum values

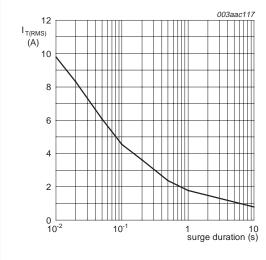


Non-repetitive peak on-state current as a function of the number of sinusoidal current cycles; maximum Fig 2. values



(1) dI_T/dt limit

Fig 3. Non-repetitive peak on-state current as a function of pulse duration; maximum values



f = 50 Hz

T_{lead} = 70 °C

RMS on-state current as a function of surge Fig 4. duration; maximum values

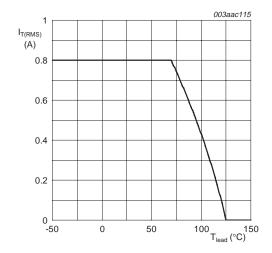


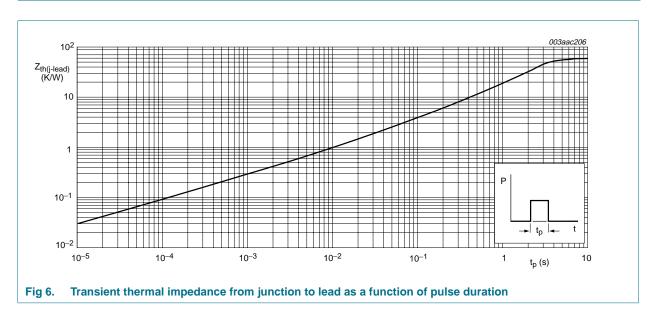
Fig 5. RMS on-state current as a function of lead temperature; maximum values

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5. Thermal characteristics

Table 4. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j\text{-lead})}$	thermal resistance from junction to lead	full cycle; see Figure 6	-	-	60	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient	printed circuit board mounted; lead length 4 mm	-	150	-	K/W



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Static characteristics

Static characteristics Table 5.

 $T_i = 25 \,^{\circ}C$ unless otherwise specified.

Symbol	Parameter	Conditions	BTA2008-600D BTA2008-800D			BTA2008-600E BTA2008-800E			Unit
			Min	Тур	Max	Min	Тур	Max	
I_{GT}	gate trigger current	$V_D = 12 \text{ V; } I_T = 0.1 \text{ A; see } \frac{\text{Figure 8}}{}$							
		T2+ G+	0.25	-	5	0.5	-	10	mΑ
		T2+ G-	0.25	-	5	0.5	-	10	mΑ
		T2- G-	0.25	-	5	0.5	-	10	mΑ
I _L latching curre	latching current	$V_D = 12 \text{ V}; I_{GT} = 0.1 \text{ A};$ see Figure 10							
		T2+ G+	-	-	10	-	-	12	mA
		T2+ G-	-	-	20	-	-	20	mΑ
		T2- G-	-	-	10	-	-	12	mΑ
I _H	holding current	$V_D = 12 \text{ V; } I_{GT} = 0.1 \text{ A;}$ see Figure 11	-	-	10	-	-	12	mA
V_{T}	on-state voltage	I _T = 0.85 A; see <u>Figure 9</u>	-	1.35	1.6	-	1.35	1.6	V
V_{GT}	gate trigger voltage	$V_D = 12 \text{ V; } I_T = 0.1 \text{ A; see } \frac{\text{Figure 7}}{}$	-	0.9	2	-	0.9	2	V
		$V_D = 400 \text{ V}; I_T = 0.1 \text{ A}; T_j = 125 ^{\circ}\text{C}$	0.2	0.3	-	0.2	0.3	-	V
I _D	off-state current	$V_D = V_{DRM(max)}$; $T_j = 125 ^{\circ}C$	-	0.1	0.5	-	0.1	0.5	mΑ

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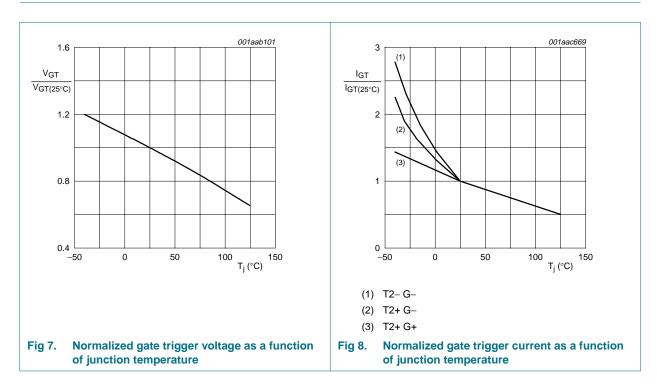
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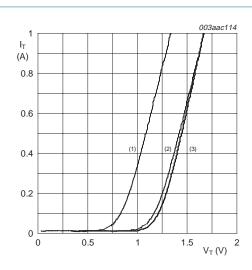
Dynamic characteristics

Table 6. **Dynamic characteristics**

Symbol	Parameter	Conditions	BTA2008-600D BTA2008-800D			BTA2008-600E BTA2008-800E			Unit
			Min	Тур	Max	Min	Тур	Max	
dV _D /dt	rate of rise of off-state voltage	$V_{DM} = 0.67 \times V_{DRM(max)};$ $T_j = 125$ °C; exponential waveform; gate open circuit	200	-	-	600	-	-	V/μs
dI _{com} /dt	rate of change of commutating current	$\begin{split} V_{DM} = 400 \text{ V; } T_j = 125 \text{ °C;} \\ I_{T(RMS)} = 0.8 \text{ A;} \\ dV/dt = 10 \text{ V/}\mu\text{s; gate open} \\ circuit \end{split}$	0.5	-	-	1.6	-	-	A/ms
t _{gt}	gate-controlled turn-on time	$I_{TM} = 1 \text{ A}; V_D = V_{DRM(max)};$ $I_G = 0.1 \text{ A}; dI_G/dt = 5 \text{ A}/\mu\text{s}$	-	2	-	-	2	-	μs



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 $V_0 = 0.835 \text{ V}$

 $R_s = 0.5 \Omega$

- (1) $T_j = 125 \,^{\circ}\text{C}$; typical values
- (2) T_i = 125 °C; maximum values
- (3) $T_i = 25$ °C; maximum values

On-state current as a function of on-state Fig 9.

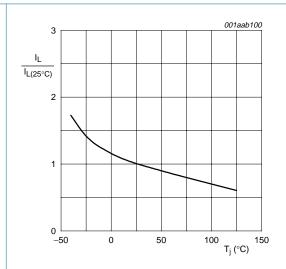


Fig 10. Normalized latching current as a function of junction temperature

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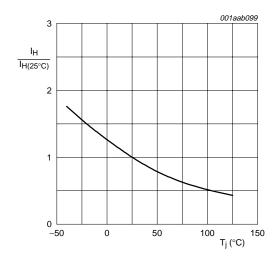


Fig 11. Normalized holding current as a function of junction temperature

Package outline

Plastic single-ended leaded (through hole) package; 3 leads

SOT54

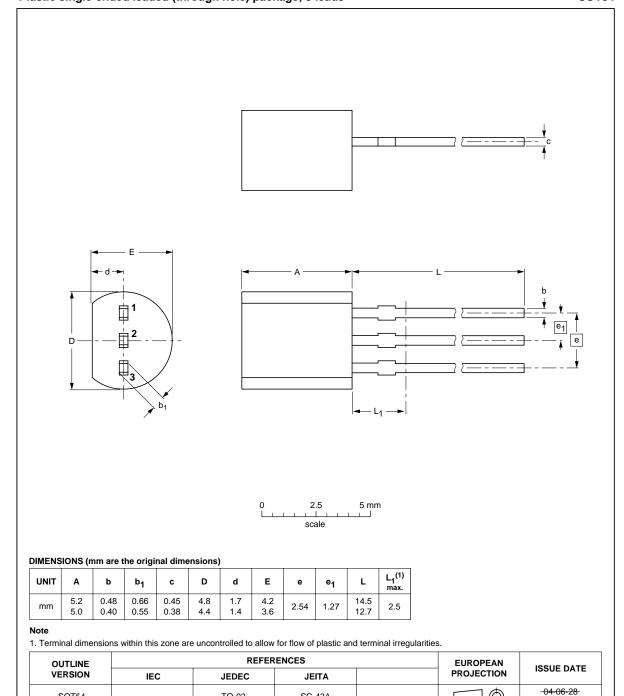


Fig 12. Package outline SOT54 (TO-92)

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SC-43A

TO-92

SOT54

04-11-16

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Revision history

Table 7. **Revision history**

Document ID	Release date	Data sheet status	Change notice	Supersedes
BTA2008_SER_D_E_1	20080118	Product data sheet	-	-

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10.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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